

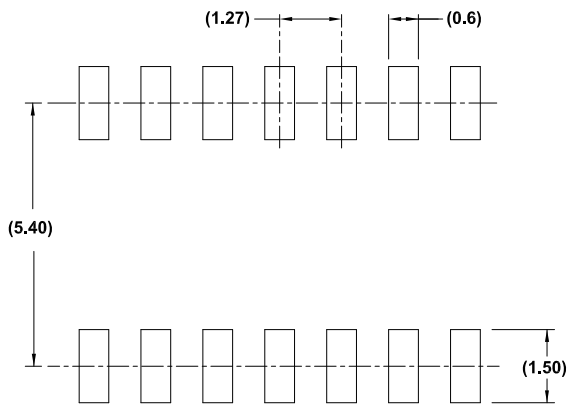
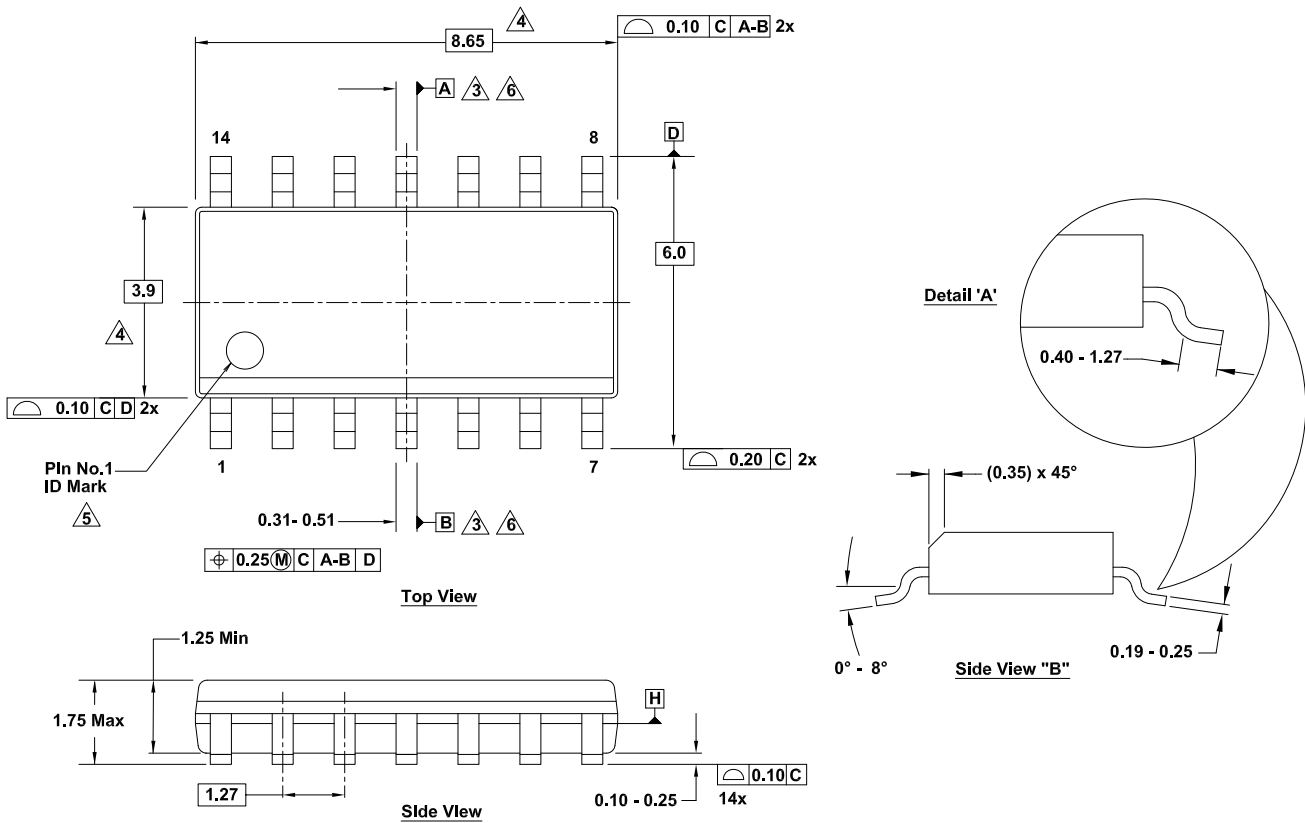
# Plastic Packages for Integrated Circuits

## Package Outline Drawing

M14.15

14 Lead Narrow Body Small Outline Plastic Package

Rev 2, 6/20



Typical Recommended Land Pattern

**Notes:**

1. Dimensions are in millimeters. Dimensions in ( ) for reference only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. Datums A and B are determined at Datum H.
4. Dimension does not include interlead flash or protrusions. Interlead flash or protrusions shall not exceed 0.25mm per side.
5. The pin #1 identifier can be either a mold or mark feature.
6. Does not include dambar protrusion. Allowable dambar protrusion shall be 0.10mm total in excess of lead width at maximum condition.
7. Reference to JEDEC MS-012-AB.